

Silicon Carbide Schottky Barrier Diode



Features

- Temperature Independent Switching Behavior
- High Surge Current Capability
- Positive Temperature Coefficient on VF
- Low Conduction Loss
- Zero Reverse Recovery
- High junction temperature 175 °C
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case: TO-263 molded plastic
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0487 ounces, 1.38 grams

Application

• PFC, UPS, PV Inverter, Welder

Maximum Ratings and Thermal Characteristics (Tc = 25 °C unless otherwise specified)

PARAMETE	SYMBOL	LIMIT	UNITS		
Repetitive Peak Reverse Voltage	Vrrm	1200	V		
DC Blocking Voltage	V _{DC}	1200	V		
Continuous Forward Current	Tc= 150 °C	IF	20	А	
Repetitive Peak Surge Current	$T_{C}=25 \circ C$, $t_{p}=10 ms$		76	A	
Half Sine Wave, D=0.1	$T_C=125 \ ^{\circ}C$, $t_p =10ms$	IFRM	56		
Peak Forward Surge Current	$T_C= 25 \circ C$, $t_p = 10 ms$		152	A	
Half Sine Wave	$T_C=125 \ ^{\circ}C$, $t_p =10ms$		128		
Peak Forward Surge Current $t_p = 10us$, Pulse	IFSM	960	A		
Maximum Power Dissipation	P _{total}	267.9	W		
Operating Junction Temperature Ra	TJ	-55~175	°C		
Storage Temperature Range	Tstg	-55~175	٥C		





Electrical Characteristics ($T_c = 25$ °C unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Forward Voltage Drop	VF	I _F = 20 A, T _J = 25 °C	-	1.5	1.7	- V	
		I _F = 20 A, T _J = 175 °C	-	2.0	-		
Reverse Leakage Current	IR	V _R = 1200 V, T _J = 25 °C	-	15	180	μA	
		V _R = 1200 V, T _J = 175 °C	-	0.07	-	mA	
Total Capacitive Charge	Qc	I _F = 20 A, V _R = 800V	-	87	-	nC	
Total Capacitance	С	$V_R = 1V$, f = 1MHz	-	1040	-	pF	
		V _R = 400V, f = 1MHz	-	77	-	pF	
		V _R = 800V, f = 1MHz	-	57	-	pF	
Capacitance Stored Energy	Ec	V _R = 800V	-	25.8	-	μJ	
Thermal Resistance	Rejc		-	0.56	-	°C/W	











Fig.2 Reverse Characteristics





Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PCDB20120G1	TO-263	50pcs / Tube	
		800pcs / Reel	CDB20120G1

Packaging Information & Mounting Pad Layout







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